## TL3275 Series Tact Switch



Applications / Markets


## Specifications

Electrical Rating: $50 \mathrm{~mA}, 12 \mathrm{VDC}$
Contact Resistance: $500 \mathrm{~m} \Omega$ Max. (Initial)
Insulation Resistance: $100 \mathrm{M} \Omega$ Min. at 100VDC
Dielectric Strength: 250VAC for 1 Minute
Operating Temperature: $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Operating Force: $160 \mathrm{gf} \pm 50 \mathrm{gf}$
Operating Life: 100,000 cycles
Travel: $0.20 \mathrm{~mm} \pm 0.10 \mathrm{~mm}$
Function: SPST, Off-(On)
Bounce: 10msec Max.
Packaging: Tape and Reel
Contact Material: Silver (550 pcs/reel); Gold (1,400 pcs/reel)

## Features \& Benefits

- Right angle surface mount design
- Multiple LED options including dual LED
- Up to 100,000 cycle life expectancy
- Tape and Reel packaging
- Silver or Gold contact material


## Part Number Configurator

Series

E-SWITCH ${ }^{\circ}$ $\qquad$

## Body Dimensions



1.50
$[.059 \mathrm{in}]$

[. 031 in ]


## Body Dimensions <br> Tape and Reel


$\qquad$

## Recommended <br> Solder Process

Most contamination problems can be prevented by exercising care during the cleaning and soldering process. Care should be taken not to immerse or spray unsealed switches during flux removal. Contact E-Switch for specific soldering recommendations and specifications not shown. Generalized soldering procedures are outlined below.

## "TYPICAL" SMT REFLOW (Pb and Pb-Free)

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
| :---: | :---: | :---: |
| Average Ramp-Up Rate ( $\mathrm{Ts}_{\text {max }}$ to Tp ) | $3^{\circ} \mathrm{C} /$ second max. | $3^{\circ} \mathrm{C} /$ second max. |
| Preheat -Temperature $\mathrm{Min}\left(\mathrm{T} s_{\text {min }}\right)$ -Temperature $\mathrm{Max}^{\left(T s_{\text {max }}\right)}$ -Time $\left(\mathrm{ts}_{\text {min }}\right.$ to $\left.\mathrm{ts} \mathrm{s}_{\max }\right)$ | $\begin{gathered} 100{ }^{\circ} \mathrm{C} \\ 150^{\circ} \mathrm{C} \\ 60-120 \text { seconds } \end{gathered}$ | $\begin{gathered} 150^{\circ} \mathrm{C} \\ 200^{\circ} \mathrm{C} \\ 60-180 \text { seconds } \end{gathered}$ |
| Time Maintained above: <br> -Temperature ( $\mathrm{T}_{\mathrm{L}}$ ) <br> -Time ( $\mathrm{t}_{\mathrm{L}}$ ) | $\begin{gathered} 183{ }^{\circ} \mathrm{C} \\ 60-150 \text { seconds } \end{gathered}$ | $\begin{gathered} 217{ }^{\circ} \mathrm{C} \\ 60-150 \text { seconds } \end{gathered}$ |
| Time within $5^{\circ} \mathrm{C}$ of actual Peak Temperature (tp) | 10-30 seconds | 20-40 seconds |
| Ramp-Down Rate | $6^{\circ} \mathrm{C} /$ second max. | $6^{\circ} \mathrm{C} /$ second max. |
| Time $25^{\circ} \mathrm{C}$ to Peak Temperature | 6 minutes max. | 8 minutes max. |

Note 1: All temperatures refer to topside of the package, measured on the package surface.


